

# Chip NTC Thermistor

## Features

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## Applications

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## PART NUMBER

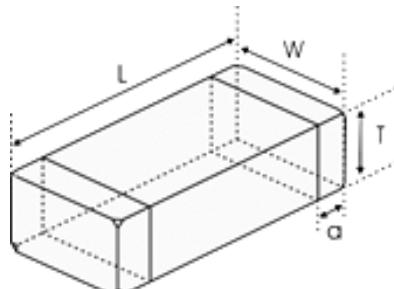
Example: RND 155QN0805X103F3435FA

RND 155QN0805	X	103	F	3435	F	A
Type RND 155QN0402: 0402 RND 155QN0603: 0603 RND 155QN0805: 0805	Delimeter	Nominal Resistance 472 = 4.7 kΩ 103 = 10 kΩ 104 = 100 kΩ	Tolerance F = ± 1% G = ± 2% H = ± 3% J = ± 5 %	B Constant 3435 = 3435 K 3950 = 3950 K 4050 = 4050 K 4500 = 4500 K	Tolerance of B Constant F = ± 1% H = ± 3%	B Constant Calculation Method A = 25 °C & 85 °C B = 25 °C & 50 °C

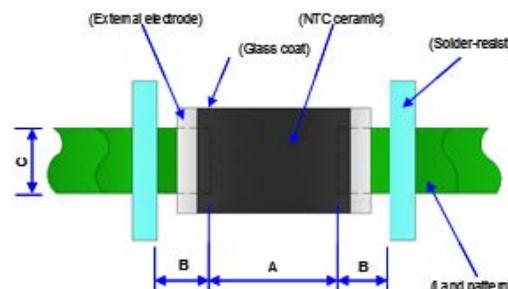
## Electrical Characteristics

Type	Resistance @ 25 °C	B Constant @ 25 / 50 °C	B Constant @ 25 / 85 °C	Permissible Operating Current @ 25 °C	Dissipation Factor	Thermal Time Constant	Rated Electric Power @ 25 °C	Operating Ambient Temperature
RND 155QN0805X103F3435FA	10 kΩ ±1%	3380 K	3435 K±1%	0.44 mA	2 mW / °C	<5 s	100 mW	-40 ... 125 °C

## Shape and Dimensions



Dimensions



Recommended PCB pattern for reflow soldering

Type	L	W	T	a	A	B	#
0402	1 mm	0.5 mm	0.5 mm	0.25 mm	0.45 ... 0.55 mm	0.4 ... 0.5 mm	...
0603	1.6 mm	0.8 mm	0.8 mm	0.3 mm	0.6 ... 0.8 mm	0.6 ... 0.7 mm	...
0805	2 mm	1.25 mm	0.85 mm	0.5 mm	1 ... 1.1 mm	0.6 ... 0.7 mm	... mm

## Test and Measurement Procedures

Unless otherwise specified, the standard atmospheric conditions for measurement/test as

- Ambient Temperature:  $20 \pm 15^\circ\text{C}$
- Relative Humidity:  $65 \pm 20\%$
- Air Pressure: 86 kPa to 106 kPa

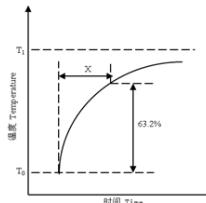
If any doubt on the results, measurements/tests should be made within the following limits

- Ambient Temperature:  $20 \pm 2^\circ\text{C}$
- Relative Humidity:  $65 \pm 5\%$
- Air Pressure: 86 kPa to 106 kPa

### Inspection Equipment

- Visual Examination: 20x magnifier
- Resistance value test: Thermistor resistance tester

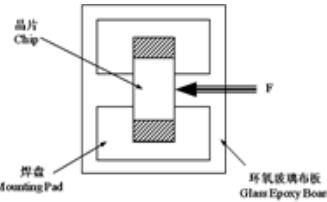
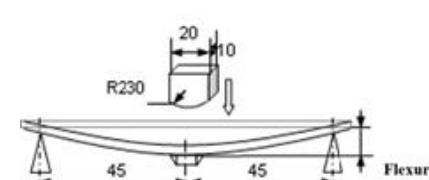
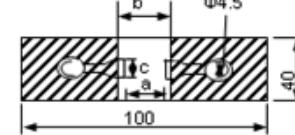
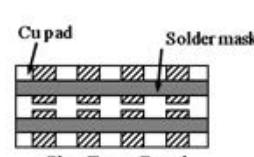
## Electrical Test

Item	Test Methods and Remarks
Nominal Zero-Power Resistance at $25^\circ\text{C}$ (R25)	Ambient temperature: $25 \pm 0.05^\circ\text{C}$ Measuring electric power: $\leq 0.1 \text{ mW}$
Nominal B Constant	$25 \pm 0.05^\circ\text{C}$ , $50 \pm 0.05^\circ\text{C}$ , $85 \pm 0.05^\circ\text{C}$ Measure the resistance at the ambient temperature of $25 \pm 0.05^\circ\text{C}$ , $50 \pm 0.05^\circ\text{C}$ or $85 \pm 0.05^\circ\text{C}$ $B(25-50^\circ\text{C}) = \frac{\ln R_{25} - \ln R_{50}}{1/T_{25} - 1/T_{50}}$ $B(25-85^\circ\text{C}) = \frac{\ln R_{25} - \ln R_{85}}{1/T_{25} - 1/T_{85}}$ T: (K) Absolute temperature (K)
Thermal Time Constant	The total time for the temperature of the thermistor to change by 63.2% of the difference from ambient temperature $T_0$ ( $^\circ\text{C}$ ) to $T_1$ ( $^\circ\text{C}$ ) by the drastic change of the power applied to thermistor from non-zero Power to Zero-Power state, normally expressed in second (S) 

Item	Test Methods and Remarks
Dissipation Factor	The required power which makes the NTC thermistor body temperature raise $1^\circ\text{C}$ through self-heated, normally expressed in milliwatts per degree Celsius ( $\text{mW}/^\circ\text{C}$ ). It can be calculated by the following formula $\delta = WT - T_0$
Rated Power	The necessary electric power makes thermistor's temperature rise $100^\circ\text{C}$ by self-heating at ambient temperature $25^\circ\text{C}$
Permissible Operating Current	The current that keep body temperature of chip NTC on the PC board in still air rising $1^\circ\text{C}$ by self-heating

# Chip NTC Thermistor

## Reliability Test

Item	Standard	Test Methods and Remarks	Requirements																												
Terminal Strength	IEC 60068-2-21	Solder the chip to the testing jig (glass epoxy board shown in the right) using eutectic solder. Then apply a force in the direction of the arrow.  <table border="1"> <thead> <tr> <th>Size</th><th>F</th><th>Duration</th></tr> </thead> <tbody> <tr> <td>0402, 0603</td><td>5N</td><td>10 ± 1 s</td></tr> <tr> <td>0805</td><td>10N</td><td></td></tr> </tbody> </table>	Size	F	Duration	0402, 0603	5N	10 ± 1 s	0805	10N		No removal or split of the termination or other defects shall occur   <p>晶片 Chip 焊盘 Mounting Pad 环氧玻璃布板 Glass Epoxy Board</p>																			
Size	F	Duration																													
0402, 0603	5N	10 ± 1 s																													
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Resistance to Flexure	IEC 60068-2-21	Solder the chip to the test jig (glass epoxy board shown in the right) using a eutectic solder. Then apply a force in the direction shown as follow   <table border="1"> <thead> <tr> <th>Size</th><th>Flexure</th><th>Pressurizing Speed</th><th>Duration</th></tr> </thead> <tbody> <tr> <td>0402, 0603</td><td>1 mm</td><td>&lt;0.5 mm/s</td><td>10 ± 1 s</td></tr> <tr> <td>0805</td><td>2 mm</td><td></td><td></td></tr> </tbody> </table>	Size	Flexure	Pressurizing Speed	Duration	0402, 0603	1 mm	<0.5 mm/s	10 ± 1 s	0805	2 mm			1. No visible damage 2. $ \Delta R_{25}/R_{25}  \leq 5\%$  <table border="1"> <thead> <tr> <th>Size</th><th>a</th><th>b</th><th>c</th></tr> </thead> <tbody> <tr> <td>0402</td><td>0.4 mm</td><td>1.5 mm</td><td>0.5 mm</td></tr> <tr> <td>0603</td><td>1 mm</td><td>3 mm</td><td>1.2 mm</td></tr> <tr> <td>0805</td><td>1.2 mm</td><td>4 mm</td><td>1.65 mm</td></tr> </tbody> </table> 	Size	a	b	c	0402	0.4 mm	1.5 mm	0.5 mm	0603	1 mm	3 mm	1.2 mm	0805	1.2 mm	4 mm	1.65 mm
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Vibration	IEC 60068-2-80	1. Solder the chip to the testing jig (glass epoxy board shown in the left) using eutectic solder  2. The chip shall be subjected to a simple harmonic motion having total amplitude of 1.5 mm, the frequency being varied uniformly between the approximate limits of 10 and 55 Hz  3. The frequency ranges from 10 to 55 Hz and return to 10 Hz shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total of 6 hours)	No visible damage  																												
Dropping	IEC 60068-2-32	Drop a chip 10 times on a concrete floor from a height of 1 meter	No visible damage																												

# Chip NTC Thermistor



Item	Standard	Test Methods and Remarks	Requirements															
Solderability	IEC 60068-2-58	<ul style="list-style-type: none"> <li>Solder temperature: <math>245 \pm 5^\circ\text{C}</math></li> <li>Duration: <math>10 \pm 1\text{s}</math></li> <li>Solder: Sn/3.0Ag/0.5Cu</li> <li>Flux: 25% resin and 75% ethanol in weight</li> </ul>	<ol style="list-style-type: none"> <li>No visible damage</li> <li>Wetting shall exceed 95% coverage</li> </ol>															
Resistance to Soldering Heat	IEC 60068-2-58	<ul style="list-style-type: none"> <li>Solder temperature: <math>245 \pm 5^\circ\text{C}</math></li> <li>Duration: <math>10 \pm 1\text{s}</math></li> <li>Solder: Sn/3.0Ag/0.5Cu</li> <li>Flux: 25% resin and 75% ethanol in weight</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring</li> </ul>	<ol style="list-style-type: none"> <li>No visible damage</li> <li><math> \Delta R_{25}/R_{25}  \leq 5\%</math></li> <li><math> \Delta B/B  \leq 2\%</math></li> </ol>															
Temperature Cycling	IEC 60068-2-14	<p>5 cycles of following sequence without loading</p> <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature</th> <th>Time</th> </tr> </thead> <tbody> <tr> <td>1</td> <td><math>-40 \pm 5^\circ\text{C}</math></td> <td><math>30 \pm 3\text{min}</math></td> </tr> <tr> <td>2</td> <td><math>25 \pm 2^\circ\text{C}</math></td> <td><math>5 \pm 3\text{min}</math></td> </tr> <tr> <td>3</td> <td><math>125 \pm 2^\circ\text{C}</math></td> <td><math>30 \pm 3\text{min}</math></td> </tr> <tr> <td>4</td> <td><math>25 \pm 2^\circ\text{C}</math></td> <td><math>5 \pm 3\text{min}</math></td> </tr> </tbody> </table>	Step	Temperature	Time	1	$-40 \pm 5^\circ\text{C}$	$30 \pm 3\text{min}$	2	$25 \pm 2^\circ\text{C}$	$5 \pm 3\text{min}$	3	$125 \pm 2^\circ\text{C}$	$30 \pm 3\text{min}$	4	$25 \pm 2^\circ\text{C}$	$5 \pm 3\text{min}$	<ol style="list-style-type: none"> <li>No visible damage</li> <li><math> \Delta R_{25}/R_{25}  \leq 3\%</math></li> <li><math> \Delta B/B  \leq 2\%</math></li> </ol>
Step	Temperature	Time																
1	$-40 \pm 5^\circ\text{C}$	$30 \pm 3\text{min}$																
2	$25 \pm 2^\circ\text{C}$	$5 \pm 3\text{min}$																
3	$125 \pm 2^\circ\text{C}$	$30 \pm 3\text{min}$																
4	$25 \pm 2^\circ\text{C}$	$5 \pm 3\text{min}$																
Resistance to Dry Heat	IEC 60068-2-2	<ol style="list-style-type: none"> <li><math>125 \pm 5^\circ\text{C}</math> in air, for <math>1000 \pm 24</math> hours without loading</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring</li> </ol>	<ol style="list-style-type: none"> <li>No visible damage</li> <li><math> \Delta R_{25}/R_{25}  \leq 5\%</math></li> <li><math> \Delta B/B  \leq 2\%</math></li> </ol>															
Resistance to Cold	IEC 60068-2-1	<ol style="list-style-type: none"> <li><math>-40 \pm 3^\circ\text{C}</math> in air, for <math>1000 \pm 24</math> hours without loading</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring</li> </ol>	<ol style="list-style-type: none"> <li>No visible damage</li> <li><math> \Delta R_{25}/R_{25}  \leq 5\%</math></li> <li><math> \Delta B/B  \leq 2\%</math></li> </ol>															
Resistance to Damp Heat	IEC 60068-2-78	<ol style="list-style-type: none"> <li><math>40 \pm 2^\circ\text{C}</math>, 90~95%RH in air, for <math>1000 \pm 2</math> hours without loading</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring</li> </ol>	<ol style="list-style-type: none"> <li>No visible damage</li> <li><math> \Delta R_{25}/R_{25}  \leq 3\%</math></li> <li><math> \Delta B/B  \leq 2\%</math></li> </ol>															
Resistance to high temperature load	IEC 60539-1 5.25.4	<ol style="list-style-type: none"> <li><math>85 \pm 2^\circ\text{C}</math> in air with permissive operating current for <math>1000 \pm 48</math> hours</li> <li>The chip shall be stabilized at normal condition for 1~2 hours before measuring</li> </ol>	<ol style="list-style-type: none"> <li>No visible damage</li> <li><math> \Delta R_{25}/R_{25}  \leq 5\%</math></li> <li><math> \Delta B/B  \leq 2\%</math></li> </ol>															

## Storage

### Storage Conditions

- Storage Temperature:  $-10^\circ\text{C} \sim 40^\circ\text{C}$
- Relative Humidity:  $\leq 75\%$ RH
- Keep away from corrosive atmosphere and sunlight
- Period of Storage: 6 Months after delivery

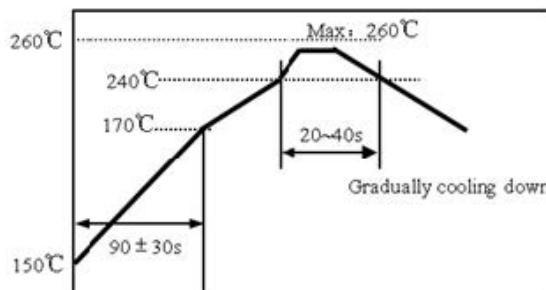
## Notes & Warnings

The RND 155QN series thermistors shall not be operated and stored under the following environmental conditions:

- Corrosive or deoxidized atmospheres (such as chlorine, sulfurated hydrogen, ammonia, sulfuric acid, nitric oxide and so on)
- Volatile or inflammable atmospheres
- Dusty condition
- Excessively high or low pressure condition
- Humid site
- Places with brine, oil, chemical liquid or organic solvent
- Intense vibration
- Places with analogously deleterious conditions
- The ceramic body of the RND 155QN series thermistors is fragile, no excessive pressure or impact shall be exerted on it
- The RND 155QN series thermistors shall not be operated beyond the specified "Operating Temperature Range" in the catalog

## Re-Flowing Profile

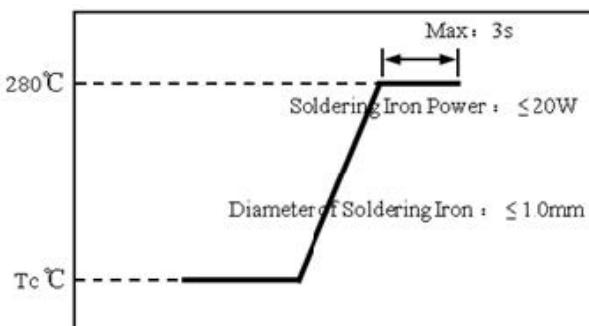
- 1~2°C/sec. Ramp
- Pre-heating: 150~170°C/90±30 sec.
- Time above 240°C: 20~40 sec.
- Peak temperature: 260°C Max./10 sec.
- Solder paste: Sn/3.0Ag/0.5Cu
- Max.2 times for re-flowing



## Iron Soldering Profile

- Iron soldering power: Max.20W
- Pre-heating: 150°C/60sec.
- Soldering Tip temperature: 280°C Max.
- Soldering time: 3 sec Max.
- Solder paste: Sn/3.0Ag/0.5Cu
- Max.1 times for iron soldering

Note: Take care not to apply the tip of the soldering iron to the terminal electrodes



# Chip NTC Thermistor



R-T Table

Temp. (°C)	R_Min (Kohm)	R_Cent (Kohm)	R_Max (Kohm)	Res TOL.	Temp. TOL.(°C)
-40	189.674	197.390	205.400	4.06%	0.69
-39	179.349	186.540	194.000	4.00%	0.69
-38	169.647	176.350	183.299	3.94%	0.68
-37	160.550	166.800	173.276	3.88%	0.68
-36	151.990	157.820	163.857	3.83%	0.67
-35	143.951	149.390	155.019	3.77%	0.67
-34	136.431	141.510	146.763	3.71%	0.66
-33	129.347	134.090	138.993	3.66%	0.66
-32	122.680	127.110	131.687	3.60%	0.65
-31	116.391	120.530	124.804	3.55%	0.65
-30	110.472	114.340	118.332	3.49%	0.64
-29	104.913	108.530	112.260	3.44%	0.64
-28	99.658	103.040	106.526	3.38%	0.63
-27	94.706	97.870	101.129	3.33%	0.63
-26	90.029	92.989	96.037	3.28%	0.62
-25	85.611	88.381	91.231	3.23%	0.62
-24	81.443	84.036	86.702	3.17%	0.61
-23	77.504	79.931	82.426	3.12%	0.60
-22	73.779	76.052	78.387	3.07%	0.60
-21	70.256	72.384	74.569	3.02%	0.59
-20	66.922	68.915	70.961	2.97%	0.59
-19	63.767	65.634	67.549	2.92%	0.58
-18	60.779	62.529	64.323	2.87%	0.58
-17	57.949	59.589	61.269	2.82%	0.57
-16	55.268	56.804	58.377	2.77%	0.56
-15	52.726	54.166	55.640	2.72%	0.56
-14	50.315	51.665	53.046	2.67%	0.55
-13	48.029	49.294	50.588	2.62%	0.55
-12	45.860	47.046	48.258	2.58%	0.54
-11	43.801	44.913	46.049	2.53%	0.53
-10	41.846	42.889	43.953	2.48%	0.53
-9	39.989	40.967	41.964	2.43%	0.52
-8	38.225	39.142	40.077	2.39%	0.51
-7	36.549	37.408	38.284	2.34%	0.51
-6	34.955	35.761	36.582	2.30%	0.50
-5	33.440	34.196	34.965	2.25%	0.49
-4	31.998	32.707	33.428	2.20%	0.49
-3	30.627	31.291	31.966	2.16%	0.48
-2	29.322	29.945	30.578	2.11%	0.47
-1	28.080	28.664	29.257	2.07%	0.47
0	26.898	27.445	28.001	2.02%	0.46
1	25.770	26.283	26.804	1.98%	0.45

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2	24.696	25.177	25.665	1.94%	0.45
3	23.673	24.124	24.581	1.89%	0.44
4	22.699	23.121	23.549	1.85%	0.43
5	21.769	22.165	22.566	1.81%	0.42
6	20.882	21.253	21.628	1.76%	0.42
7	20.037	20.384	20.735	1.72%	0.41
8	19.230	19.555	19.883	1.68%	0.40
9	18.460	18.764	19.071	1.64%	0.39
10	17.725	18.010	18.297	1.60%	0.39
11	17.024	17.290	17.559	1.55%	0.38
12	16.353	16.602	16.853	1.51%	0.37
13	15.713	15.946	16.181	1.47%	0.36
14	15.101	15.319	15.538	1.43%	0.36
15	14.517	14.720	14.925	1.39%	0.35
16	13.958	14.148	14.339	1.35%	0.34
17	13.424	13.601	13.779	1.31%	0.33
18	12.913	13.078	13.244	1.27%	0.32
19	12.424	12.578	12.733	1.23%	0.32
20	11.955	12.099	12.243	1.19%	0.31
21	11.508	11.642	11.776	1.15%	0.30
22	11.079	11.204	11.329	1.11%	0.29
23	10.669	10.785	10.901	1.08%	0.28
24	10.276	10.384	10.492	1.04%	0.27
25	9.900	10.000	10.100	1.00%	0.27
26	9.532	9.632	9.732	1.04%	0.28
27	9.180	9.280	9.380	1.08%	0.29
28	8.843	8.943	9.042	1.11%	0.30
29	8.520	8.619	8.718	1.15%	0.31
30	8.211	8.309	8.408	1.19%	0.33
31	7.914	8.012	8.110	1.22%	0.34
32	7.630	7.727	7.824	1.26%	0.35
33	7.357	7.453	7.550	1.30%	0.36
34	7.096	7.191	7.287	1.33%	0.37
35	6.845	6.939	7.034	1.37%	0.39
36	6.604	6.698	6.792	1.41%	0.40
37	6.373	6.466	6.559	1.44%	0.41
38	6.152	6.243	6.335	1.48%	0.43
39	5.939	6.029	6.120	1.51%	0.44
40	5.735	5.824	5.914	1.55%	0.45
41	5.538	5.627	5.716	1.58%	0.46
42	5.350	5.437	5.525	1.62%	0.48
43	5.169	5.255	5.342	1.65%	0.49
44	4.995	5.080	5.165	1.69%	0.50
45	4.828	4.911	4.996	1.72%	0.52
46	4.667	4.749	4.832	1.75%	0.53
47	4.512	4.593	4.675	1.79%	0.54

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48	4.363	4.443	4.524	1.82%	0.56
49	4.220	4.299	4.379	1.86%	0.57
50	4.083	4.160	4.239	1.89%	0.58
51	3.950	4.027	4.104	1.92%	0.60
52	3.823	3.898	3.974	1.96%	0.61
53	3.700	3.774	3.849	1.99%	0.63
54	3.582	3.654	3.728	2.02%	0.64
55	3.468	3.539	3.612	2.05%	0.65
56	3.358	3.429	3.500	2.09%	0.67
57	3.252	3.322	3.392	2.12%	0.68
58	3.151	3.219	3.288	2.15%	0.70
59	3.052	3.119	3.188	2.18%	0.71
60	2.958	3.024	3.091	2.22%	0.72
61	2.867	2.931	2.997	2.25%	0.74
62	2.779	2.842	2.907	2.28%	0.75
63	2.694	2.756	2.820	2.31%	0.77
64	2.612	2.673	2.736	2.34%	0.78
65	2.533	2.593	2.655	2.37%	0.80
66	2.457	2.516	2.576	2.40%	0.81
67	2.383	2.441	2.501	2.43%	0.83
68	2.312	2.369	2.428	2.46%	0.84
69	2.244	2.300	2.357	2.50%	0.86
70	2.177	2.233	2.289	2.53%	0.87
71	2.113	2.168	2.223	2.56%	0.89
72	2.052	2.105	2.159	2.59%	0.90
73	1.992	2.044	2.098	2.62%	0.92
74	1.934	1.986	2.038	2.65%	0.93
75	1.879	1.929	1.981	2.68%	0.95
76	1.825	1.874	1.925	2.71%	0.96
77	1.773	1.821	1.871	2.73%	0.98
78	1.722	1.770	1.819	2.76%	1.00
79	1.673	1.720	1.768	2.79%	1.01
80	1.626	1.673	1.720	2.82%	1.03
81	1.581	1.626	1.672	2.85%	1.04
82	1.537	1.581	1.627	2.88%	1.06
83	1.494	1.538	1.582	2.91%	1.08
84	1.453	1.496	1.540	2.94%	1.09
85	1.413	1.455	1.498	2.97%	1.11
86	1.374	1.416	1.458	2.99%	1.13
87	1.337	1.377	1.419	3.02%	1.14
88	1.300	1.340	1.381	3.05%	1.16
89	1.265	1.304	1.345	3.08%	1.17
90	1.231	1.270	1.309	3.11%	1.19
91	1.198	1.236	1.275	3.13%	1.21
92	1.167	1.204	1.242	3.16%	1.23
93	1.136	1.172	1.209	3.19%	1.24

94	1.106	1.141	1.178	3.22%	1.26
95	1.076	1.112	1.148	3.24%	1.28
96	1.048	1.083	1.118	3.27%	1.29
97	1.021	1.055	1.090	3.30%	1.31
98	0.995	1.028	1.062	3.32%	1.33
99	0.969	1.002	1.035	3.35%	1.35
100	0.944	0.976	1.009	3.38%	1.36
101	0.920	0.951	0.984	3.40%	1.38
102	0.897	0.927	0.959	3.43%	1.40
103	0.874	0.904	0.935	3.46%	1.42
104	0.852	0.882	0.912	3.48%	1.43
105	0.830	0.860	0.890	3.51%	1.45
106	0.810	0.838	0.868	3.53%	1.47
107	0.790	0.818	0.847	3.56%	1.49
108	0.770	0.798	0.826	3.59%	1.50
109	0.751	0.778	0.806	3.61%	1.52
110	0.733	0.759	0.787	3.64%	1.54
111	0.715	0.741	0.768	3.66%	1.56
112	0.697	0.723	0.750	3.69%	1.58
113	0.680	0.706	0.732	3.71%	1.60
114	0.664	0.689	0.715	3.74%	1.61
115	0.648	0.673	0.698	3.76%	1.63
116	0.633	0.657	0.682	3.79%	1.65
117	0.618	0.641	0.666	3.81%	1.67
118	0.603	0.626	0.650	3.84%	1.69
119	0.589	0.612	0.635	3.86%	1.71
120	0.575	0.598	0.621	3.89%	1.73
121	0.562	0.584	0.607	3.91%	1.75
122	0.549	0.570	0.593	3.93%	1.77
123	0.536	0.557	0.579	3.96%	1.79
124	0.524	0.545	0.566	3.98%	1.80
125	0.512	0.532	0.554	4.01%	1.82